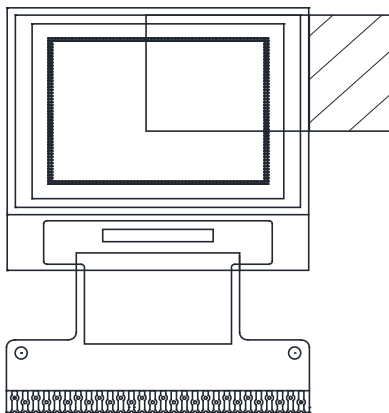


## 64 x 48 Graphic OLED



### FEATURES

- Type: graphic
- Display format: 64 x 48 dots
- Built-in controller: SSD1306BZ
- Duty cycle: 1/48
- +3 V power supply
- Interface: 6800, 8080, SPI, I<sup>2</sup>C
- With polarizer
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
COMPLIANT

MECHANICAL DATA		
ITEM	STANDARD VALUE	UNIT
Module dimension	18.46 x 18.10 x 1.3	mm
Viewing area	15.42 x 12.06	
Active area	13.42 x 10.06	
Dot size	0.185 x 0.185	
Dot pitch	0.210 x 0.210	
Mounting hole	n/a	

ABSOLUTE MAXIMUM RATINGS				
ITEM	SYMBOL	STANDARD VALUE		UNIT
		MIN.	MAX.	
Supply voltage for logic <sup>(1)(2)</sup>	V <sub>DD</sub>	0	4	V
Supply voltage for display <sup>(1)(2)</sup>	V <sub>CC</sub>	0	15	V
Operating temperature	T <sub>OP</sub>	-40	+80	°C
Storage temperature	T <sub>STG</sub>	-40	+80	

### Notes

- <sup>(1)</sup> All the above voltages are on the basis of "V<sub>SS</sub> = 0 V"
- <sup>(2)</sup> When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate

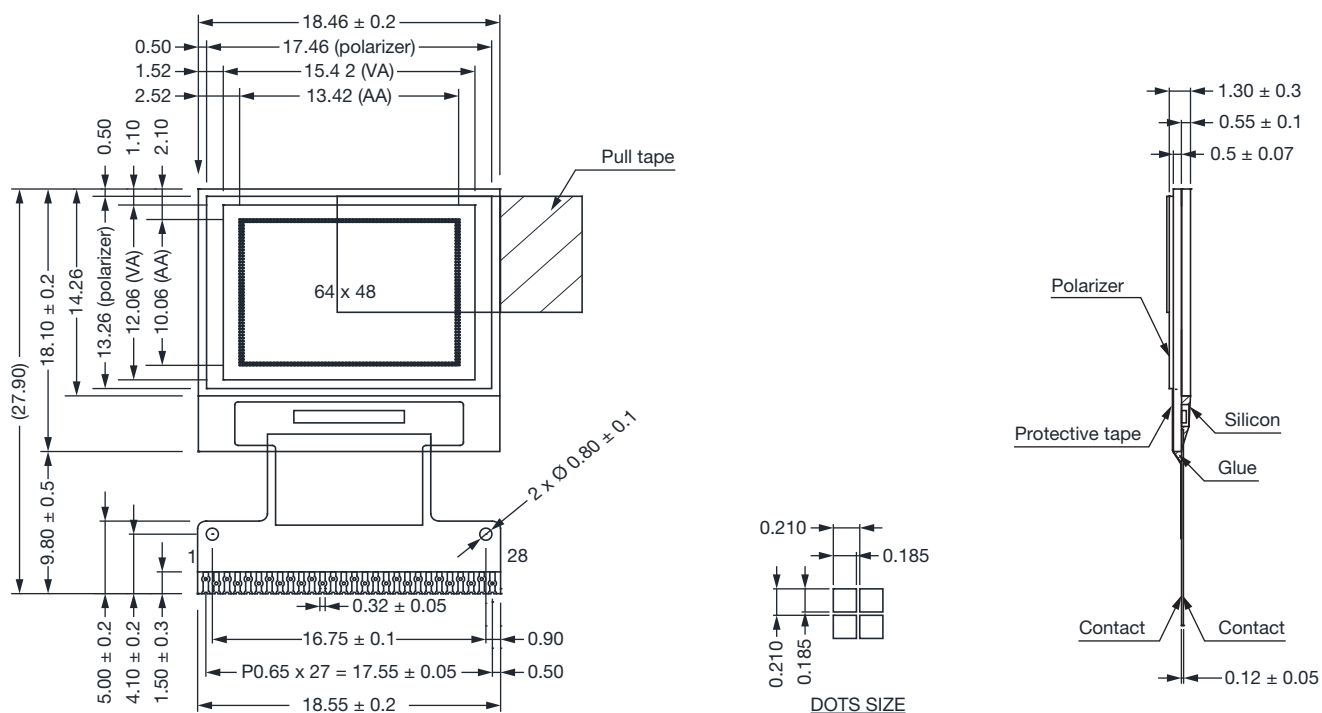
ELECTRICAL CHARACTERISTICS						
ITEM	SYMBOL	CONDITION	STANDARD VALUE			UNIT
			MIN.	TYP.	MAX.	
Supply voltage for logic	V <sub>DD</sub>	-	2.8	3.0	3.3	V
Supply voltage for display	V <sub>CC</sub>	-	7.0	7.25	7.5	
Input high voltage	V <sub>IH</sub>	-	0.8 V <sub>DD</sub>	-	V <sub>DDI/O</sub>	
Input low voltage	V <sub>IL</sub>	-	0	-	0.2 V <sub>DD</sub>	
Output high voltage	V <sub>OH</sub>	-	0.9 V <sub>DD</sub>	-	V <sub>DDI/O</sub>	
Output low voltage	V <sub>OL</sub>	-	0	-	0.1 V <sub>DD</sub>	
50 % check board operating current	I <sub>CC</sub>	V <sub>CC</sub> = 7.25 V	-	6.0	13.0	mA

OPTIONS				
EMITTING COLOR				
YELLOW	GREEN	RED	BLUE	WHITE
Yes	-	-	-	-



INTERFACE PIN FUNCTION						
PIN NO.	SYMBOL	FUNCTION				
1	ESD GND	It should be connected to the ground				
2	C2N	Positive terminal of the flying inverting capacitor negative terminal of the flying boost capacitor The charge-pump capacitors are required between the terminals. They must be floated when the converter is not used				
3	C2P					
4	C1P					
5	C1N					
6	V <sub>BAT</sub>	Power supply for DC/DC converter circuit This is the power supply pin for the internal buffer of the DC/DC voltage converter. It must be connected to external source when the converter is used. It should be connected to V <sub>DD</sub> when the converter is not used.				
7	V <sub>SS</sub>	This is a ground pin				
8	V <sub>DD</sub>	Power supply pin for core logic operation				
9	BS1	MCU bus interface selection pins				
			6800-parallel (8 bit)	8080-parallel (8 bit)	4-wire serial	I <sup>2</sup> C
10	BS2	BS0	0	0	0	0
		BS1	0	1	0	1
		BS2	1	1	0	0
11	CS#	Chip select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low				
12	RES#	Power reset for controller and driver This pin is reset signal input. When the pin is low, initialization of the chip is executed				
13	D / C#	This is data / command control pin. When it is pulled “high” (i.e. connect to V <sub>DD</sub> ), the data at D (7 : 0) is treated as data. When it is pulled “low”, the data at D (7 : 0) will be transferred to the command register. In I <sup>2</sup> C mode, this pin acts as SA0 for slave address selection. When 3-wire serial interface is selected, this pin must be connected to V <sub>SS</sub>				
14	R / W#	This is read / write control input pin connecting to the MCU interface. When interfacing to a 6800-series microprocessor, this pin will be used as read / write (R / W#) selection input. Read mode will be carried out when this pin is pulled “high” (i.e. connect to V <sub>DD</sub> ) and write mode when “low”				
15	E / RD#	When interfacing to a 6800-series microprocessor, this pin will be used as the enable (E) signal. Read / write operation is initiated when this pin is pulled “high” (i.e. connect to V <sub>DD</sub> ) and the chip is selected. When connecting to an 8080-series microprocessor, this pin receives the read (RD#) signal. Read operation is initiated when this pin is pulled “low” and the chip is selected. When serial or I <sup>2</sup> C interface is selected, this pin must be connected to V <sub>SS</sub>				
16 to 23	D0 to D7	These are 8-bit bi-directional data bus to be connected to the microprocessor’s data bus. When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SDIN. When I <sup>2</sup> C mode is selected, D2, D1 should be tied together and serve as SDA <sub>out</sub> , SDA <sub>in</sub> in application and D0 is the serial clock input, SCL				
24	I <sub>REF</sub>	This is segment output current reference pin. When external I <sub>REF</sub> is used, a resistor should be connected between this pin and V <sub>SS</sub> to maintain the I <sub>REF</sub> current at a maximum of 30 μA. Please refer to Fig. 7 to Fig. 15 for the details of resistor value. When internal I <sub>REF</sub> is used, this pin should be kept NC				
25	V <sub>COMH</sub>	Voltage output high level for COM signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and V <sub>SS</sub>				
26	V <sub>CC</sub>	Power supply for OEL panel This is the most positive voltage supply pin of the chip. A stabilization capacitor should be connected between this pin and V <sub>SS</sub> when the converter is used. It must be connected to external source when the converter is not used				
27	V <sub>LSS</sub>	This is an analog ground pin. It should be connected to V <sub>SS</sub> externally				
28	ESD GND	It should be connected to ground				

**DIMENSIONS** in millimeters



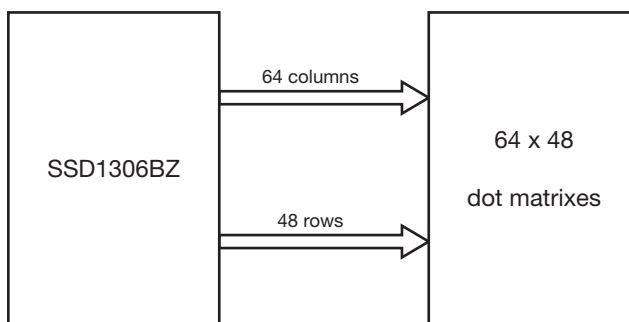
The non-specified tolerance of dimension is  $\pm 0.3$  mm

**MODULE CLASSIFICATION INFORMATION**

<b>OLED</b>	<b>-</b>	<b>064</b>	<b>O</b>	<b>048</b>	<b>A</b>	<b>-</b>	<b>L</b>	<b>P</b>	<b>P</b>	<b>3</b>	<b>N</b>	<b>0</b>	<b>0</b>	<b>000</b>
1	2	3	4	5	6	7	8	9	10	11	12	13		
1	Brand		Vishay Intertechnology, Inc.											
2	Horizontal format		64 columns											
3	Display type		F: COG type, with frame H: graphic type N: character type O: COG type Y: tab type											
4	Vertical format		48 lines											
5	Serials code		A											
6	Emitting color		A: amber B: blue C: full color G: green L: yellow R: red S: sky blue W: white X: yellow / sky blue (dual color) Y: yellow green											
7	Polarizer		N: without polarizer P: with polarizer											
8	Display mode		A: active matrix P: passive matrix											
9	Driver voltage		3: 3.0 V to 3.3 V 5: 5.0 V											
10	Touch panel		N: without touch panel T: with touch panel											
11	Products type		0: standard 1: sunlight readable 2: transparent OLED (TOLED) 3: flexible OLED 4: OLED for lighting											
12	Product grades		0: standard (A level) 2: B level 3: C level 4: high class (AA level) 5: customer offerings											
13	Serial number		Application serial number (000 to ZZZ)											

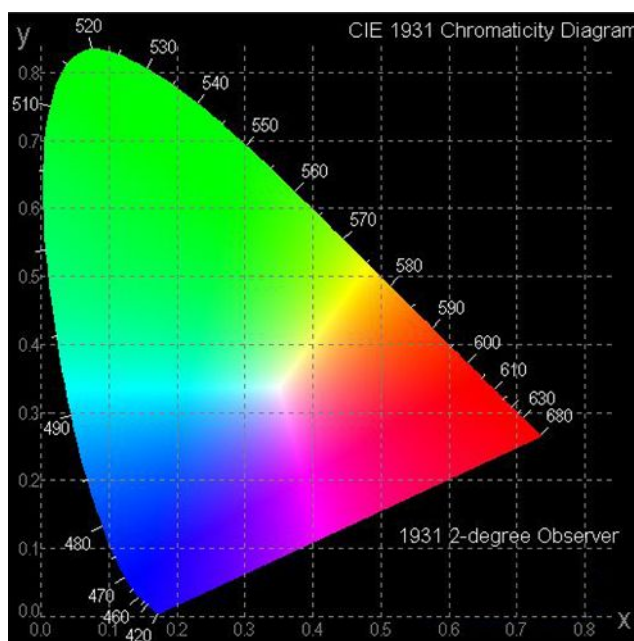
**GENERAL SPECIFICATIONS**

ITEM	DIMENSION	UNIT
Number of characters	64 x 48 dots	
Module dimension	18.46 x 18.10 x 1.3	mm
View area	15.42 x 12.06	mm
Active area	13.42 x 10.06	mm
Dot size	0.185 x 0.185	mm
Dot pitch	0.210 x 0.210	mm
Panel type	OLED, yellow	
Duty	1/48	
IC	SDD1306BZ	

**FUNCTION BLOCK DIAGRAM****Note**

- For more information, please refer to Application Note provided by Vishay

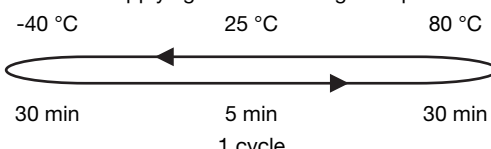
OPTICAL CHARACTERISTICS						
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
View angle	(V) $\theta$		160	-	-	deg
	(H) $\phi$		160	-	-	
Contrast ratio	CR	Dark	2000 : 1	-	-	-
Response time	$t_{rise}$		-	10	-	$\mu s$
	$t_{fall}$		-	10	-	$\mu s$
Display with 50 % check board brightness			120	150	-	cd/m <sup>2</sup>
CIE <sub>x</sub> (yellow)	(CIE1931)		0.45	0.47	0.49	
CIE <sub>y</sub> (yellow)	(CIE1931)		0.48	0.50	0.52	



OLED LIFETIME			
ITEM	CONDITIONS	MIN.	TYP.
Operating life time	T <sub>A</sub> = 25 °C, initial 50 % check board brightness typical value	50 000 h	-

**Notes**

- Life time is defined the amount of time when the luminance has decayed to < 50 % of the initial value
- This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (PDF) for the product under normal use conditions
- Screen saving mode will extend OLED lifetime

<b>RELIABILITY</b>		
<b>ENVIRONMENTAL TEST</b>		
<b>TEST ITEM</b>	<b>CONTENT OF TEST</b>	<b>TEST CONDITION</b>
High temperature storage	Endurance test applying the high storage temperature for a long time	80 °C, 240 h
Low temperature storage	Endurance test applying the low storage temperature for a long time	-40 °C, 240 h
High temperature operation	Endurance test applying the electric stress (voltage and current) and the thermal stress to the element for a long time	80 °C, 240 h
Low temperature operation	Endurance test applying the electric stress under low temperature for a long time	-40 °C, 240 h
High temperature / humidity storage	Endurance test applying the high temperature and high humidity storage for a long time	60 °C, 90 % RH, 240 h
Temperature cycle	Endurance test applying the low and high temperature cycle <div style="text-align: center;">  </div>	-40 °C / 80 °C, 100 cycles
<b>MECHANICAL TEST</b>		
Vibration test	Endurance test applying the vibration during transportation and using	10 Hz to 22 Hz for 1.5 mm peak-to-peak, 22 Hz to 500 Hz for 1.5 g, total 0.5 h
Shock test	Constructional and mechanical endurance test applying the shock during transportation	50 g half sin wave 11 ms, 3 times of each direction
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air	115 mbar, 40 h
<b>OTHERS</b>		
Static electricity test	Endurance test applying the electric stress to the terminal	$V_S = \pm 600 \text{ V}$ (contact), $\pm 800 \text{ V}$ (air), $R_S = 330 \Omega$ , $C_S = 150 \text{ pF}$ , 10 times

**Note**

- Supply voltage for OLED system = operating voltage at 25 °C

**TEST AND MEASUREMENT CONDITIONS**

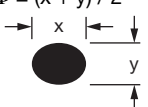

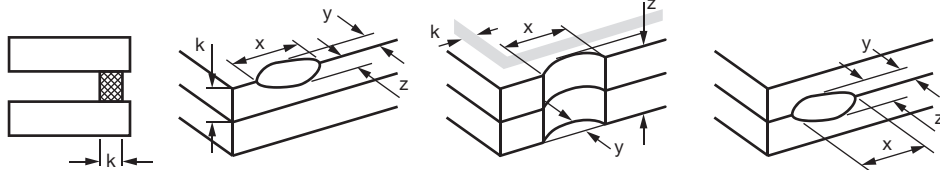
1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hours prior to conducting the failure test at  $23 \text{ °C} \pm 5 \text{ °C}$ ,  $55 \% \pm 15 \% \text{ RH}$
2. All-pixels-on is used as operation test pattern
3. The degradation of polarizer are ignored for high temperature storage, high temperature / humidity storage, temperature cycle

**EVALUATION CRITERIA**

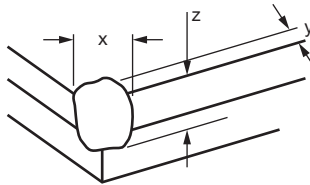
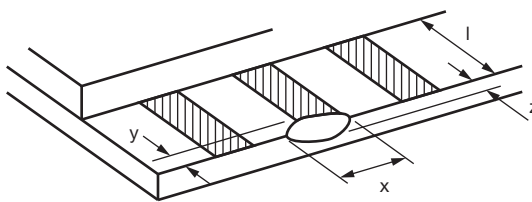
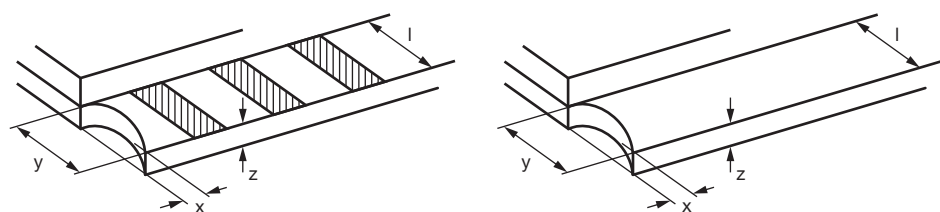
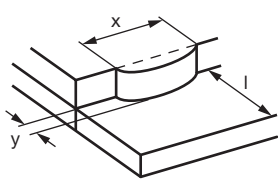
4. The function test is OK
5. No observable defects
6. Luminance:  $> 50 \%$  of initial value
7. Current consumption: within  $\pm 50 \%$  of initial value

**APPENDIX: RESIDUE IMAGE**

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

INSPECTION SPECIFICATION																		
NO.	ITEM	CRITERION	AQL															
01	Electrical testing	1.1 Missing vertical, horizontal segment, segment contrast defect 1.2 Missing character, dot or icon 1.3 Display malfunction 1.4 No function or no display 1.5 Current consumption exceeds product specifications 1.6 OLED viewing angle defect 1.7 Mixed product types 1.8 Contrast defect	0.65															
02	Black or white spots on OLED (display only)	2.1 White and black spots on display ≤ 0.25 mm, no more than three white or black spots present 2.2 Densely spaced: no more than two spots or lines within 3 mm	2.5															
03	OLED black spots, white spots, contamination (non-display)	3.1 Round type: as following drawing $\Phi = (x + y) / 2$ 	<table><tr><th>SIZE</th><th>ACCEPTABLE QTY</th></tr><tr><td><math>\Phi \leq 0.10</math></td><td>Accept no dense</td></tr><tr><td><math>0.10 &lt; \Phi \leq 0.20</math></td><td>2</td></tr><tr><td><math>0.20 &lt; \Phi \leq 0.25</math></td><td>1</td></tr><tr><td><math>0.25 &lt; \Phi</math></td><td>0</td></tr></table>	SIZE	ACCEPTABLE QTY	$\Phi \leq 0.10$	Accept no dense	$0.10 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.25$	1	$0.25 < \Phi$	0	2.5				
		SIZE	ACCEPTABLE QTY															
$\Phi \leq 0.10$	Accept no dense																	
$0.10 < \Phi \leq 0.20$	2																	
$0.20 < \Phi \leq 0.25$	1																	
$0.25 < \Phi$	0																	
		3.2 Line type (as following drawing) 	<table><tr><th>LENGTH</th><th>WIDTH</th><th>ACCEPTABLE QTY</th></tr><tr><td>-</td><td><math>W \leq 0.02</math></td><td>Accept no dense</td></tr><tr><td><math>L \leq 3.0</math></td><td><math>0.02 &lt; W \leq 0.03</math></td><td rowspan="2">2</td></tr><tr><td><math>L \leq 2.5</math></td><td><math>0.03 &lt; W \leq 0.05</math></td></tr><tr><td>-</td><td><math>0.05 &lt; W</math></td><td>As round type</td></tr></table>	LENGTH	WIDTH	ACCEPTABLE QTY	-	$W \leq 0.02$	Accept no dense	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	$L \leq 2.5$	$0.03 < W \leq 0.05$	-	$0.05 < W$	As round type	2.5
LENGTH	WIDTH	ACCEPTABLE QTY																
-	$W \leq 0.02$	Accept no dense																
$L \leq 3.0$	$0.02 < W \leq 0.03$	2																
$L \leq 2.5$	$0.03 < W \leq 0.05$																	
-	$0.05 < W$	As round type																
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	<table><tr><th>SIZE <math>\Phi</math></th><th>ACCEPTABLE QTY</th></tr><tr><td><math>\Phi \leq 0.20</math></td><td>Accept no dense</td></tr><tr><td><math>0.20 &lt; \Phi \leq 0.50</math></td><td>3</td></tr><tr><td><math>0.50 &lt; \Phi \leq 1.00</math></td><td>2</td></tr><tr><td><math>1.00 &lt; \Phi</math></td><td>0</td></tr><tr><td>Total QTY</td><td>3</td></tr></table>	SIZE $\Phi$	ACCEPTABLE QTY	$\Phi \leq 0.20$	Accept no dense	$0.20 < \Phi \leq 0.50$	3	$0.50 < \Phi \leq 1.00$	2	$1.00 < \Phi$	0	Total QTY	3	2.5		
SIZE $\Phi$	ACCEPTABLE QTY																	
$\Phi \leq 0.20$	Accept no dense																	
$0.20 < \Phi \leq 0.50$	3																	
$0.50 < \Phi \leq 1.00$	2																	
$1.00 < \Phi$	0																	
Total QTY	3																	
05	Scratches	Follow no. 3 OLED black spots, white spots, contamination																
06	Chipped glass	Symbols: x: chip length k: seal width l: electrode pad length 6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:  <table><tr><th>z: chip thickness</th><th>y: chip width</th><th>x: chip length</th></tr><tr><td><math>z \leq 1/2 t</math></td><td>Not over viewing area</td><td><math>x \leq 1/8 a</math></td></tr><tr><td><math>1/2 t &lt; z \leq 2 t</math></td><td>Not exceed 1/3 k</td><td><math>x \leq 1/8 a</math></td></tr></table> <b>Note</b> <ul style="list-style-type: none"><li>If there are 2 or more chips, x is total length of each chip</li></ul>	z: chip thickness	y: chip width	x: chip length	$z \leq 1/2 t$	Not over viewing area	$x \leq 1/8 a$	$1/2 t < z \leq 2 t$	Not exceed 1/3 k	$x \leq 1/8 a$	2.5						
z: chip thickness	y: chip width	x: chip length																
$z \leq 1/2 t$	Not over viewing area	$x \leq 1/8 a$																
$1/2 t < z \leq 2 t$	Not exceed 1/3 k	$x \leq 1/8 a$																


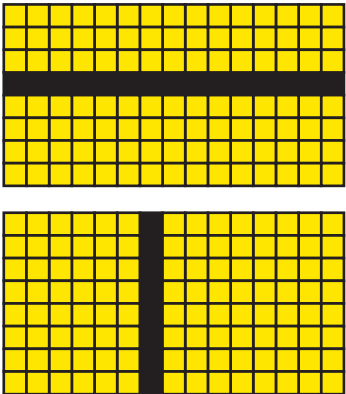
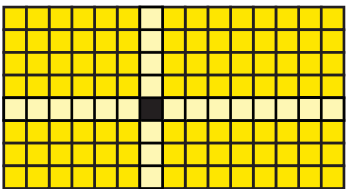
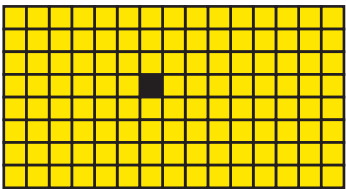
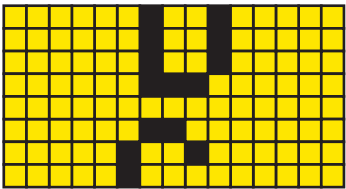
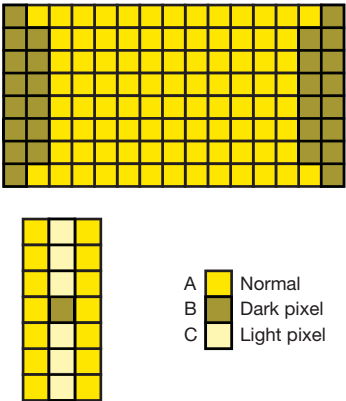


INSPECTION SPECIFICATION																			
NO.	ITEM	CRITERION	AQL																
06	Chipped glass	6.1.2 Corner crack:  <table><tr><td>z: chip thickness</td><td>y: chip width</td><td>x: chip length</td></tr><tr><td><math>z \leq 1/2 t</math></td><td>Not over viewing area</td><td><math>x \leq 1/8 a</math></td></tr><tr><td><math>1/2 t &lt; z \leq 2 t</math></td><td>Not exceed <math>1/3 k</math></td><td><math>x \leq 1/8 a</math></td></tr></table> <p><b>Note</b></p> <ul style="list-style-type: none"><li>If there are 2 or more chips, x is total length of each chip</li></ul>	z: chip thickness	y: chip width	x: chip length	$z \leq 1/2 t$	Not over viewing area	$x \leq 1/8 a$	$1/2 t < z \leq 2 t$	Not exceed $1/3 k$	$x \leq 1/8 a$	2.5							
		z: chip thickness	y: chip width	x: chip length															
$z \leq 1/2 t$	Not over viewing area	$x \leq 1/8 a$																	
$1/2 t < z \leq 2 t$	Not exceed $1/3 k$	$x \leq 1/8 a$																	
06	Glass crack	Symbols: x: chip length k: seal width l: electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:  <table><tr><td>y: chip width</td><td>x: chip length</td><td>z: chip thickness</td></tr><tr><td><math>y \leq 0.5 \text{ mm}</math></td><td><math>x \leq 1/8 a</math></td><td><math>0 &lt; z \leq t</math></td></tr></table> <p>6.2.2 Non-conductive portion: <table><tr><td>y: chip width</td><td>x: chip length</td><td>z: chip thickness</td></tr><tr><td><math>y \leq l</math></td><td><math>x \leq 1/8 a</math></td><td><math>0 &lt; z \leq t</math></td></tr></table><p><b>Notes</b></p><ul style="list-style-type: none"><li>If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications</li><li>If the product will be heat sealed by the customer, the alignment mark not be damaged</li></ul><p>6.2.3 Substrate protuberance and internal crack: <table><tr><td>y: width</td><td>x: length</td></tr><tr><td><math>y \leq 1/3 l</math></td><td><math>x \leq a</math></td></tr></table></p></p>	y: chip width	x: chip length	z: chip thickness	$y \leq 0.5 \text{ mm}$	$x \leq 1/8 a$	$0 < z \leq t$	y: chip width	x: chip length	z: chip thickness	$y \leq l$	$x \leq 1/8 a$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3 l$	$x \leq a$	2.5
y: chip width	x: chip length	z: chip thickness																	
$y \leq 0.5 \text{ mm}$	$x \leq 1/8 a$	$0 < z \leq t$																	
y: chip width	x: chip length	z: chip thickness																	
$y \leq l$	$x \leq 1/8 a$	$0 < z \leq t$																	
y: width	x: length																		
$y \leq 1/3 l$	$x \leq a$																		
07	Cracked glass	The OLED with extensive crack is not acceptable	2.5																



INSPECTION SPECIFICATION			
NO.	ITEM	CRITERION	AQL
08	Backlight elements	8.1 Illumination source flickers when lit	0.65
		8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards	2.5
		8.3 Backlight does not light or color wrong	0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination	2.5
		9.2 Bezel must comply with job specifications	0.65
10	PCB, COB	10.1 COB seal may not have pinholes larger than 0.2 mm or contamination	2.5
		10.2 COB seal surface may not have pinholes through to the IC	2.5
		10.3 The height of the COB should not exceed the height indicated in the assembly diagram	0.65
		10.4 There may not be more than 2 mm of sealant outside the seal area on the PCB. And there should be no more than three places	2.5
		10.5 No oxidation or contamination PCB terminals	2.5
		10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts	0.65
		10.7 The jumper on the PCB should conform to the product characteristic chart	0.65
		10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down	2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB	2.5
		11.2 No cold solder joints, missing solder connections, oxidation or icicle	2.5
		11.3 No residue or solder balls on PCB	2.5
		11.4 No short circuits in components on PCB	0.65
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface pin (OLB) of TCP	2.5
		12.2 No cracks on interface pin (OLB) of TCP	0.65
		12.3 No contamination, solder residue or solder balls on product	2.5
		12.4 The IC on the TCP may not be damaged, circuits	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color	2.5
		12.7 Sealant on top of the ITO circuit has not hardened	2.5
		12.8 Pin type must match type in specification sheet	0.65
		12.9 OLED pin loose or missing pins	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet	0.65
		12.11 Product dimension and structure must conform to product specification sheet	0.65



CHECK ITEM	CLASSIFICATION	CRITERIA
No display	Major	
Missing line	Major	
Pixel short	Major	
Darker short	Major	
Wrong display	Major	
Un-uniform B/A x 100 % < 70 % A/C x 100 % < 70 %	Major	

## PRECAUTIONS IN USE OF OLED MODULES

### MODULES

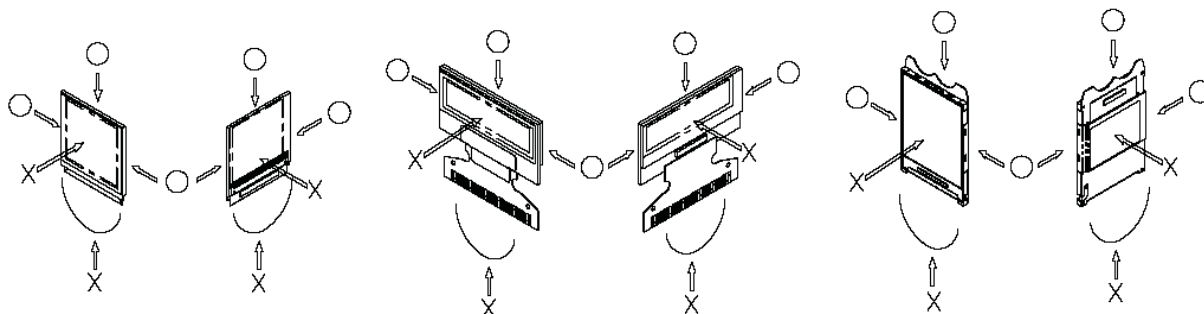
1. Avoid applying excessive shocks to module or making any alterations or modifications to it
2. Do not make extra holes on the printed circuit board, modify its shape or change the components of OLED display module
3. Do not disassemble the OLED display module
4. Do not operate it above the absolute maximum rating
5. Do not drop, bend or twist OLED display module
6. Soldering: only to the I/O terminals
7. Storage: please storage in anti-static electricity container and clean environment
8. It is pretty common to use "screen saver" to extend the lifetime and do not use fix information for long time in real application
9. Do not use fixed information in OLED panel for long time, that will extend "screen burn" effect time
10. Vishay has the right to change the passive components, including R2 and R3 adjust resistors. (Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier)
11. Vishay have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization, and the best product performance... etc, under the premise of not affecting the electrical characteristics and external dimensions, Vishay have the right to modify the version)

### HANDLING PRECAUTIONS

1. Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position
2. If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance
3. If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged and be careful not to apply pressure to these sections
4. The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module
5. When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape
  - Scotch mending tape no. 810 or an equivalent

Never try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:

  - Water
  - Ketone
  - Aromatic solvents
6. Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases



7. Do not apply stress to the LSI chips and the surrounding molded sections
8. Do not disassemble nor modify the OLED display module
9. Do not apply input signals while the logic power is off



10. Pay sufficient attention to the working environments when handling OLED display modules to prevent occurrence of element breakage accidents by static electricity
  - Be sure to make human body grounding when handling OLED display modules
  - Be sure to ground tools to use or assembly such as soldering irons
  - To suppress generation of static electricity, avoid carrying out assembly work under dry environments
  - Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film
11. Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above no. 5
12. If electric current is applied when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful to avoid the above

#### **STORAGE PRECAUTIONS**

1. When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light nor to lights of fluorescent lamps and, also, avoiding high temperature and high humidity environment or low temperature (less than 0 °C) environments. We recommend you to store these modules in the packaged state when they were shipped from Vishay. At that time, be careful not to let water drops adhere to the packages or bags nor let dewing occur with them
2. If electric current is applied when water drops are adhering to the surface of the OLED display module, when the OLED display module is being dewed or when it is placed under high humidity environments, the electrodes may be corroded and be careful about the above

#### **DESIGNING PRECAUTIONS**

1. The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen
2. To prevent occurrence of malfunctioning by noise, pay attention to satisfy the  $V_{IL}$  and  $V_{IH}$  specifications and, at the same time, to make the signal line cable as short as possible
3. We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit ( $V_{DD}$ ) (recommend value: 0.5 A)
4. Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices
5. As for EMI, take necessary measures on the equipment side basically
6. When fastening the OLED display module, fasten the external plastic housing section
7. If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module
  - Connection (contact) to any other potential than the above may lead to rupture of the IC

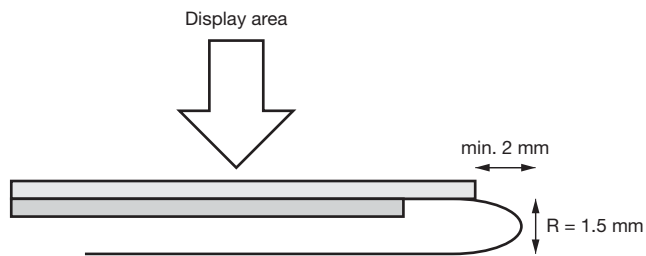
#### **PRECAUTIONS WHEN DISPOSING OF THE OLED DISPLAY MODULES**

1. Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations

#### **OTHER PRECAUTIONS**

1. When an OLED display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur. Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module
2. To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules
  - Pins and electrodes
  - Pattern layouts such as the TCP and FPC
3. With this OLED display module, the OLED driver is being exposed. Generally speaking, semiconductor elements change their characteristics when light is radiated according to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur
  - Design the product and installation method so that the OLED driver may be shielded from light in actual usage
  - Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes

4. Although this OLED display module stores the operation state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal status may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design
5. We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise
6. Resistors, capacitors, and other passive components will have different appearance and color caused by the different supplier
7. Our company will has the right to upgrade and modify the product function
8. The limitation of FPC bending





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